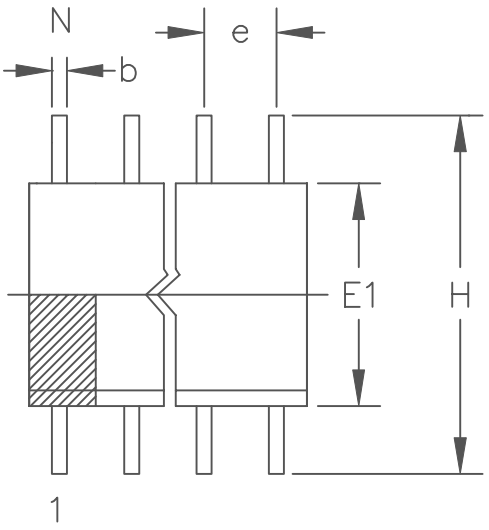
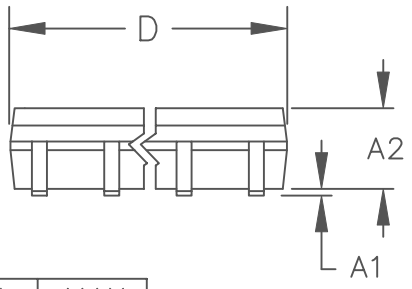
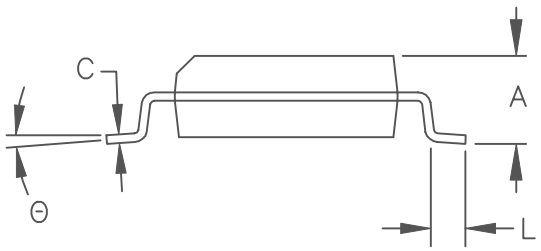
REVISIONS			
LTR	DESCRIPTION	DATE	APPROVED
A	NEW DRAWING	5/18	J.W.
B	INC. ECN NO. 8680		







LTR		MIN	MAX
A	IN.	0.094	0.105
	MM	2.39	2.67
A1	IN.	0.004	0.012
	MM	0.102	0.30
A2	IN.	0.089	0.095
	MM	2.26	2.41
b	IN.	0.013	0.020
	MM	0.33	0.51
C	IN.	0.009	0.013
	MM	0.229	0.33
e	IN.	.050 BSC	
	MM	1.27 BSC	
E1	IN.	0.290	0.300
	MM	7.37	7.62
H	IN.	0.398	0.416
	MM	10.11	10.57
L	IN.	0.016	0.040
	MM	0.40	1.02
Θ		0°	8°

		16 PIN		18 PIN		20 PIN		24 PIN		28 PIN	
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX
D	IN.	0.398	0.412	0.448	0.462	0.498	0.511	0.598	0.612	0.698	0.712
	MM	10.11	10.46	11.38	11.73	12.65	12.99	15.19	15.54	17.73	18.08

THE CHAMFER ON THE BODY IS OPTIONAL.
IF IT IS NOT PRESENT, A TERMINAL 1 IDENTIFIER MUST BE POSITIONED SO THAT 1/2 OR MORE OF IT'S AREA IS CONTAINED IN THE HATCHED ZONE.

SIGNATURE		DATE
DOC. CONTROL:	J.WILKINS	5/94
ENGR. MGR:	B.W.MCARTY	5/94
MFG. ENGR:	C.M.SELLS	5/94
CHECKED BY:	C.M.SELLS	5/94
DRAWN BY:	M.W.C.	5/94

DALLAS SEMICONDUCTOR MAXIM

TITLE

PACKAGE OUTLINE .300" SOIC 16,18,20,24&28 LD.

SIZE	FSCM NO	PART NO.	REV
A		56-G4009-001	B

DO NOT SCALE DWG. | SCALE N/A | SHEET 1 OF 1